January, 2006

FPAB30PH60



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Smart Power Module for Front-End Rectifier

General Description

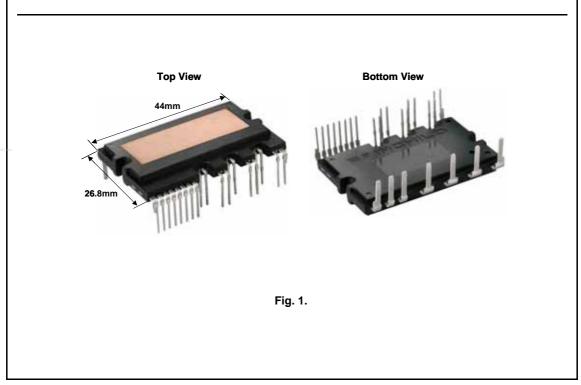
FPAB30PH60 is an advanced smart power module of PFC(Power Factor Correction) that Fairchild has newly developed and designed mainly targeting mid-power application especially for an air conditioners. It combines optimized circuit protection and drive IC matched to high frequency switching IGBTs. System reliability is futher enhanced by the integrated under-voltage lock-out and over-current protection function.

Features

- Low thermal resistance due to Al₂O₃-DBC substrate
- 600V-30A 2-phase IGBT PWM semi-converter including a drive IC for gate driving and protection
- Typical switching frequency of 20kHz
- Isolation rating of 2500Vrms/min.

Applications

• AC 180V ~ 264V single-phase front-end rectifier



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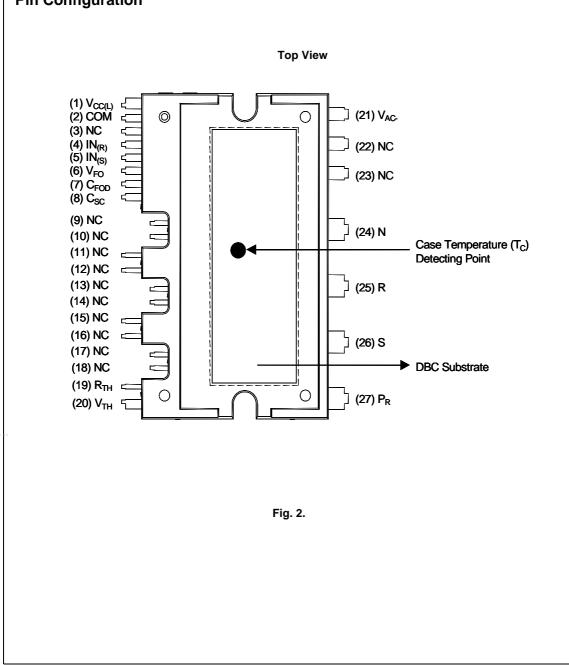
Integrated Power Functions

• PFC converter for single-phase AC/DC power conversion (Please refer to Fig. 3)

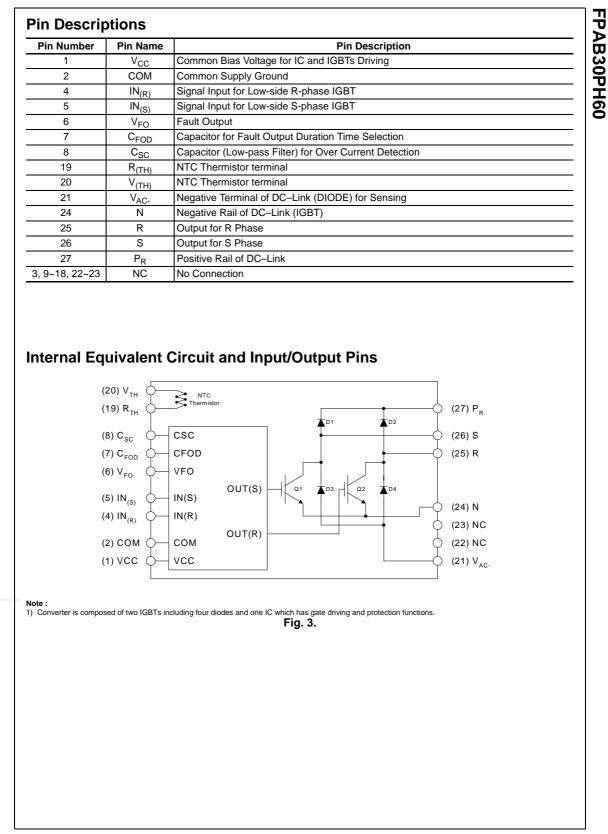
Integrated Drive, Protection and System Control Functions

- · For IGBTs: Gate drive circuit, Overcurrent circuit protection (OC), Control supply circuit under-voltage (UV) protection
- Fault signaling: Corresponding to a UV fault
- Input interface: 5V CMOS/LSTTL compatible, Schmitt trigger input

Pin Configuration



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Absolute Maximum Ratings (T_J = 25°C, Unless Otherwise Specified) **Converter Part**

Item	Symbol	Symbol Condition		Unit	
Supply Voltage	Vi	Applied between R-S	264	V _{RMS}	
Supply Voltage (Surge)	V _{i(Surge)}	Applied between R-S	500	V	
Output Voltage	V _{PN}	Applied between P- N	450	V	
Output Voltage (Surge)	V _{PN(Surge)}	Applied between P- N	500	V	
Collector-emitter Voltage	V _{CES}		600	V	
Input Current (100% Load)	li	T _C < 95°C, V _i =220V, V _{PN} = 390V, V _{PWM} =20kHz	20	A	
Input Current (125% Load) I _{i(125%}		T _C < 95°C, V _i =220V, V _{PN} = 390V, V _{PWM} =20kHz, 1min Non-repetitive	25	A	
Collector Dissipation	P _C	T _C = 25°C per One IGBT	83	W	
Operating Junction Temperature	Тј	(Note 1)	-20 ~ 125	°C	

Note 1. The maximum junction temperature rating of the power chips integrated within the SPM is 150 °C(@T_C \leq 100°C). However, to insure safe operation of the SPM, the average junction temperature should be limited to T_{J(ave)} \leq 125°C (@T_C \leq 100°C)

Control Part

ltem	Symbol	Condition	Rating	Unit
Control Supply Voltage	V _{CC}	Applied between V _{CC} - COM	20	V
Input Signal Voltage	V _{IN}	Applied between IN - COM	-0.3~5.5	V
Fault Output Supply Voltage	V _{FO}	Applied between V _{FO} - COM	-0.3~V _{CC} +0.3	V
Fault Output Current	I _{FO}	Sink Current at V _{FO} Pin	5	mA
Current Sensing Input Voltage	V _{SC}	Applied between C _{SC} - COM	-0.3~V _{CC} +0.3	V

Total System

ltem	Symbol	Condition	Rating	Unit
Module Case Operation Temperature	Т _С		-20 ~ 100	°C
Storage Temperature	T _{STG}		-40 ~ 125	°C
Isolation Voltage	V _{ISO}	60Hz, Sinusoidal, AC 1 minute, Connection Pins to DBC	2500	V _{rms}

Thermal Resistance

ltem	Symbol	Condition	Min.	Тур.	Max.	Unit
Junction to Case Thermal	R _{θ(j-c)Q}	IGBT	-	-	1.2	°C/W
Resistance	$R_{\theta(j-c)HD}$	High-side diode	-	-	2.0	°C/W
(Referenced to PKG cen- ter)	$R_{\theta(j\text{-}c)LD}$	Low-side diode	-	-	1.4	°C/W

Note :

2. For the measurement point of case temperature(T_C), please refer to Fig. 2.

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Electrical Characteristics (T_J = 25°C, Unless Otherwise Specified) **Converter Part**

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
IGBT saturation voltage	V _{CE(sat)}	V _{CC} =15V, V _{IN} = 5V; I _C =30A	-	2.4	3.1	V
High-side diode voltage	V _{FH}	I _F = 30A	-	1.9	2.5	V
Low-side diode voltage	V _{FL}	I _F = 30A	-	1.2	1.6	V
Switching Times	t _{ON}	V _{PN} = 400V, V _{CC} = 15V, I _C =30A	-	550	-	ns
	t _{C(ON)}	$V_{IN} = 0V \leftrightarrow 5V$, Inductive Load	-	200	-	ns
	t _{OFF}	(Note 3)	-	430	-	ns
	t _{C(OFF)}	(-	180	-	ns
	t _{rr}		-	60	-	ns
	I _{rr}		-	6	-	Α
Collector - emitter Leakage Current	I _{CES}	V _{CE} = V _{CES}	-	-	250	μA

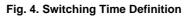
Note
t_{ON} and t_{OFF} include the propagation delay time of the internal drive IC. t_{C(ON)} and t_{C(OFF)} are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Fig. 4

Control Part

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Quiescent V _{CC} Supply Current	IQCCL	$V_{CC} = 15V, IN = 0V$ $V_{CC} - COM$	-	-	26	mA
Fault Output Voltage	V _{FOH}	$V_{SC} = 0V, V_{FO}$ Circuit: 4.7k Ω to 5V Pull-up	4.5	-	-	V
	V _{FOL}	V_{SC} = 1V, V_{FO} Circuit: 4.7k Ω to 5V Pull-up	-	-	0.8	V
Over Current Trip Level	V _{SC(ref)}	$V_{CC} = 15V$	0.45	0.5	0.55	V
Supply Circuit Under-	UV _{CCD}	Detection Level	10.7	11.9	13.0	V
Voltage Protection	UV _{CCR}	Reset Level	11.2	12.4	13.2	V
Fault-out Pulse Width	t _{FOD}	C _{FOD} = 33nF (Note 4)		1.8	2.0	ms
ON Threshold Voltage	V _{IN(ON)}	Applied between IN - COM	3.0	-	-	V
OFF Threshold Voltage	V _{IN(OFF)}		-	-	0.8	V
Resistance of Thermistor	R _{TH}	@ T _C = 25°C (Note Fig. 9)	-	50	-	kΩ
		@ T _C = 80°C (Note Fig. 9)	-	5.76	-	kΩ

Note 4. The fault-out pulse width t_{FOD} depends on the capacitance value of C_{FOD} according to the following approximate equation : $C_{FOD} = 18.3 \times 10^{-6} \times t_{FOD}[F]$

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Mechanical Characteristics and Ratings

ltem	Condition			Limits		
item		Min.	Тур.	Max.	Units	
Mounting Torque	Mounting Screw: - M3	Recommended 0.62N•m	0.51	0.62	0.72	N•m
Device Flatness	Note Fig. 5		0	-	+120	μ m
Weight			-	15.00	-	g

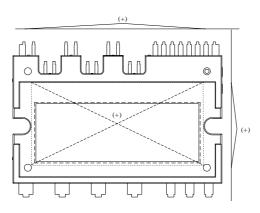
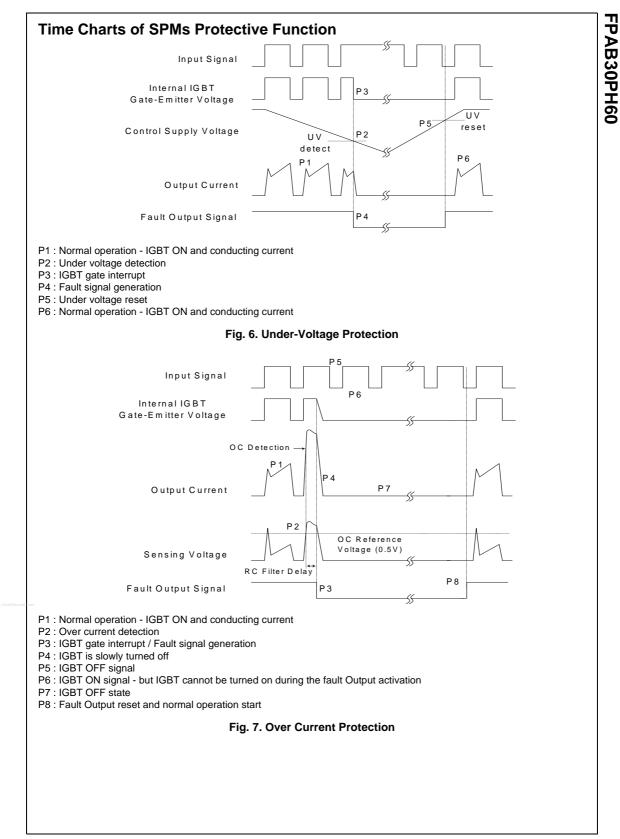
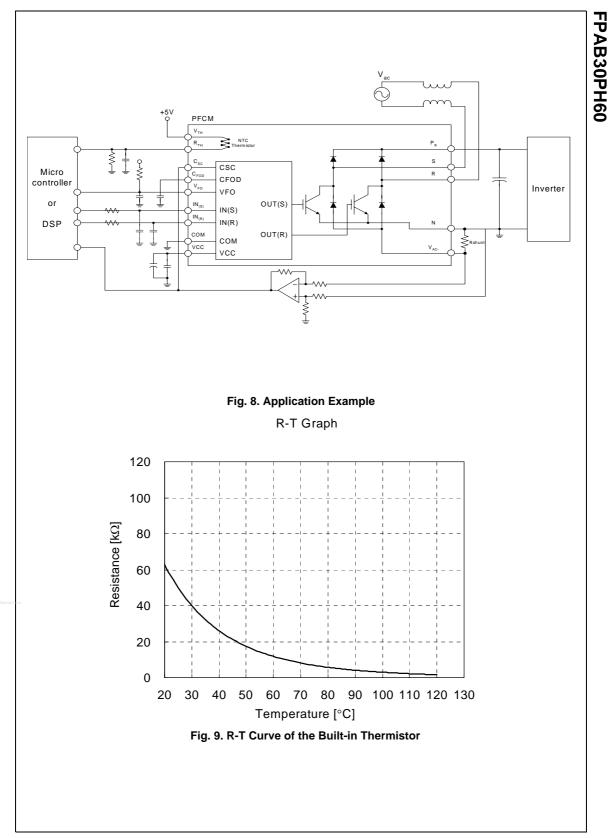


Fig. 5. Flatness Measurement Position

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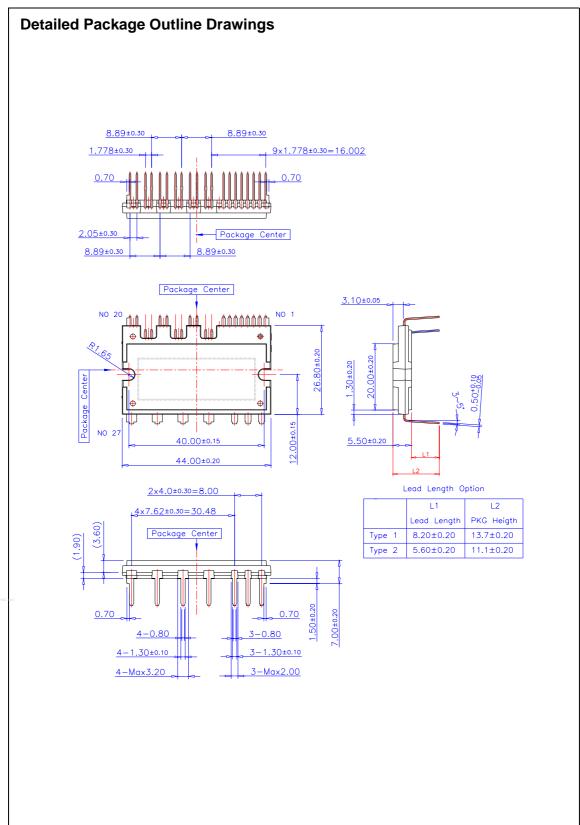


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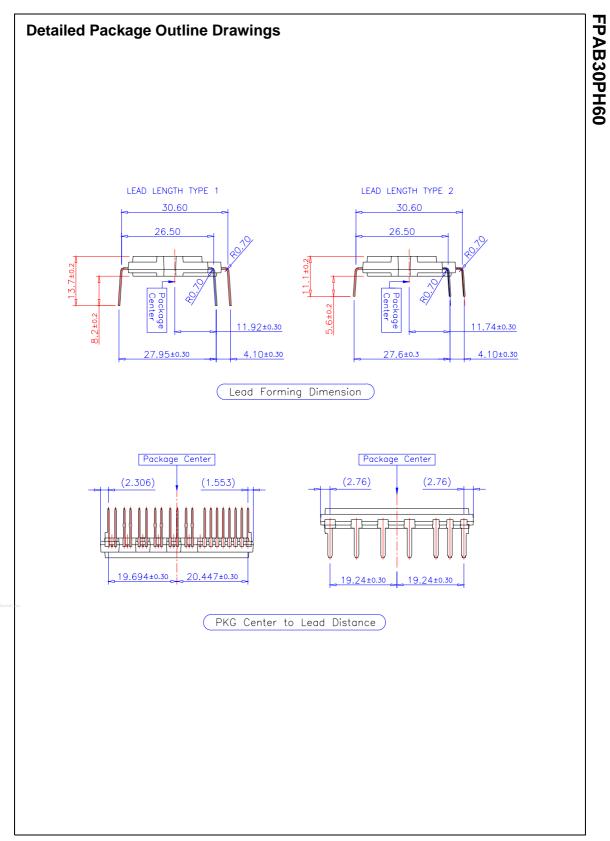
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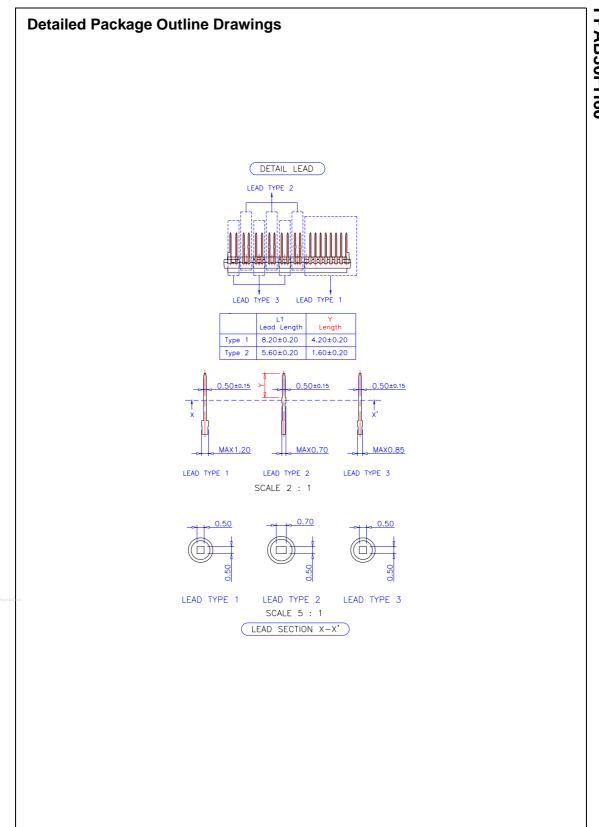


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